

03-20-2002

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RECOR

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TO THE HONORABLE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE. PLEASE RECORD THE ATTACHED ORIGINAL DOCUMENTS OR COPY THEREOF.

1. Name of conveying party(ies):

(a) Byung Hoon Ahn

(b) Jae Hun Ku

3.4.02

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and address of receiving party(ies):

Name: Amkor Technology, Inc.

Street Address: 1900 South Price Road

City: Chandler

AZ

85248-1604

Country: U.S.A.

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: (a) January 15, 2002, (b) January 14, 2002

Name and address of receiving party(ies):

Name: {Enter Name}

Street Address: {Enter Street Address}

City: {City}

State: {State}

Zip: {Zip}

Country: {Country}

Additional name(s) &amp; address(es) attached?

☐ Yes☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_

A. Patent Application No(s) - 09/845,601, filed April 26, 2001

B. Patent No(s)

Title: Lead Frame And Semiconductor Package Made Using The Leadframe

Additional numbers attached?

☐

Yes

☒

No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: James E. Parsons

Internal Address: SKJERVEN MORRILL MacPHERSON LLP

Street Address: 25 METRO DRIVE, SUITE 700

City SAN JOSE State CA Zip 95110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

☒ Authorized to be charged to Deposit Account 19-2386☒ Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James E. Parsons 34,691  
Name of Person Signing

Signature

2/19/02

Date

Total number of pages including cover sheet, attachments, and documents: 4

845194

PATENT  
REEL: 012680 FRAME: 0305

**ASSIGNMENT**

For good and valuable consideration, receipt of which is hereby acknowledged, we

<u>Byung Hoon Ahn</u>	of <u>Singapore</u>
<u>Jae Hun Ku</u>	of <u>Singapore</u>
<u>Young Suk Chung</u>	of <u>Republic of Korea</u>
<u>Suk Gu Ko</u>	of <u>Republic of Korea</u>
<u>Sung Sik Jang</u>	of <u>Republic of Korea</u>
<u>Young Nam Choi</u>	of <u>Republic of Korea</u>
<u>Won Chul Do</u>	of <u>Republic of Korea</u>

hereby sell, assign and transfer to Amkor Technology, Inc., a Delaware corporation, having a place of business at 1900 South Price Road, Chandler, AZ 85248-1604, its successors and assigns, the entire right, title and interest throughout the world in our invention in

**Lead Frame And Semiconductor Package Made Using The Leadframe**

for which we filed a United States Patent Application on April 26, 2001, which now has Serial No. 09/845,601, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 15 day of Jan, 2001. <sup>Byung</sup>

Byung Hoon Ahn

WITNESSED:

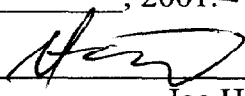
Signature

Date

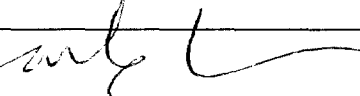
Looi Lee Hwa

Type or print name of witness

Executed this 14 day of Jan, <sup>2002</sup>~~2001~~ <sup>JH Ku</sup>

  
Jae Hun Ku

WITNESSED:

Signature   
Looi Lee Hwa

Date 14 Jan 2002

Type or print name of witness

Executed this \_\_\_\_\_ day of \_\_\_\_\_, 2001.

\_\_\_\_\_  
Young Suk Chung

WITNESSED:

Signature \_\_\_\_\_

Date \_\_\_\_\_

Type or print name of witness

Executed this \_\_\_\_\_ day of \_\_\_\_\_, 2001.

\_\_\_\_\_  
Suk Gu Ko

WITNESSED:

Signature \_\_\_\_\_

Date \_\_\_\_\_

Type or print name of witness

Executed this \_\_\_\_\_ day of \_\_\_\_\_, 2001.

\_\_\_\_\_  
Sung Sik Jang

WITNESSED:

\_\_\_\_\_  
Signature

\_\_\_\_\_  
Date

\_\_\_\_\_  
Type or print name of witness

Executed this \_\_\_\_\_ day of \_\_\_\_\_, 2001.

\_\_\_\_\_  
Young Nam Choi

WITNESSED:

\_\_\_\_\_  
Signature

\_\_\_\_\_  
Date

\_\_\_\_\_  
Type or print name of witness

Executed this \_\_\_\_\_ day of \_\_\_\_\_, 2001.

\_\_\_\_\_  
Won Chul Do

WITNESSED:

\_\_\_\_\_  
Signature

\_\_\_\_\_  
Date

\_\_\_\_\_  
Type or print name of witness